







- |   |   |   |                                       |
|---|---|---|---------------------------------------|
|  | placement area  |  | solder land plus solder paste         |
|  | solder land   |  | solder resist, 0.0625 around copper   |
|  | solder paste deposit, -0.025 around copper, stencil thickness 0.1 |   | clearance, 0.125 around occupied area |
|  | occupied area   |   | Dimensions in mm                      |

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